

Features

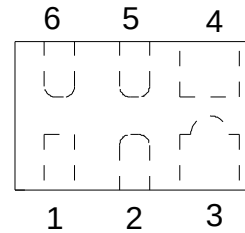
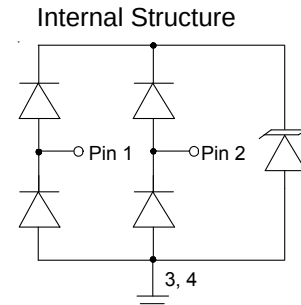
- Ultra Low Capacitance 0.5pF typical
- Low operating Voltage: 5.0 V
- Low clamping voltage
- IEC61000-4-4 (EFT) 40A (5/50ns)
- IEC61000-4-5(Lightning)5A(5/50ns)

Applications

- USB 2.0
- HDMI 1.3
- SATA and eSATA
- DVI
- IEEE 1394
- PCI Express
- Portable Electronics
- Notebooks

Mechanical Characteristics

- JEDEC SLP1610P4 package
- Molding compound flammability rating: UL 94V-0



Pin	Identification
1 - 2	Input Lines
5 - 6	Output Lines (No Internal Connection)
3 - 4	Ground

Absolute Maximum Ratings ($T_A=25^{\circ}\text{C}$ unless otherwise specified)

Parameter	Symbol	Value	Unit
Peak Pulse Power (8/20 μs)	Ppk	150	W
Peak Pulse Current (8/20 μs)	I _{PP}	5	A
ESD per IEC 61000-4-2 (Air)	VESD	± 25	kV
ESD per IEC 61000-4-2 (Contact)		± 20	
Operating Temperature Range	T _J	-55 to +125	$^{\circ}\text{C}$
Storage Temperature Range	T _{stg}	-55 to +150	$^{\circ}\text{C}$

Electrical Characteristics ($T_A=25^{\circ}\text{C}$ unless otherwise specified)

Parameter	Symbol	Min	Typ	Max	Unit	Test Condition
DP, DM, USB ID TVS						
Reverse Working Voltage	V_{RWM}			5.0	V	
Breakdown Voltage	V_{BR}	6.0			V	$I_T = 1\text{mA}$
Reverse Leakage Current	I_R			0.5	μA	$V_{RWM} = 5.0\text{V}$
Clamping Voltage	V_C			15	V	$I_{PP} = 1\text{A}$ (8 x 20 μs pulse), any I/O pin to ground
Clamping Voltage	V_C			25	V	$I_{PP} = 5\text{A}$ (8 x 20 μs pulse), any I/O pin to ground
Junction Capacitance	C_J		0.5	1.0	pF	$V_R = 0\text{V}$, $f = 1\text{MHz}$, any I/O pin to ground

Typical Characteristics

Fig1. 8/20 μ s Pulse Waveform

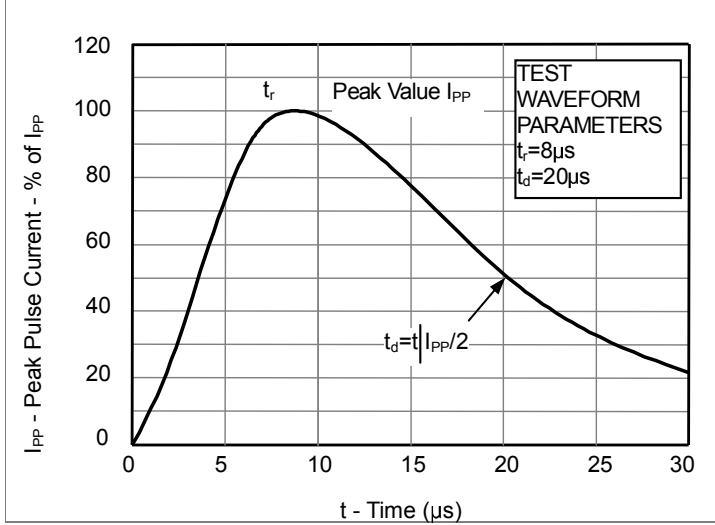


Fig2. ESD Pulse Waveform (according to IEC 61000-4-2)

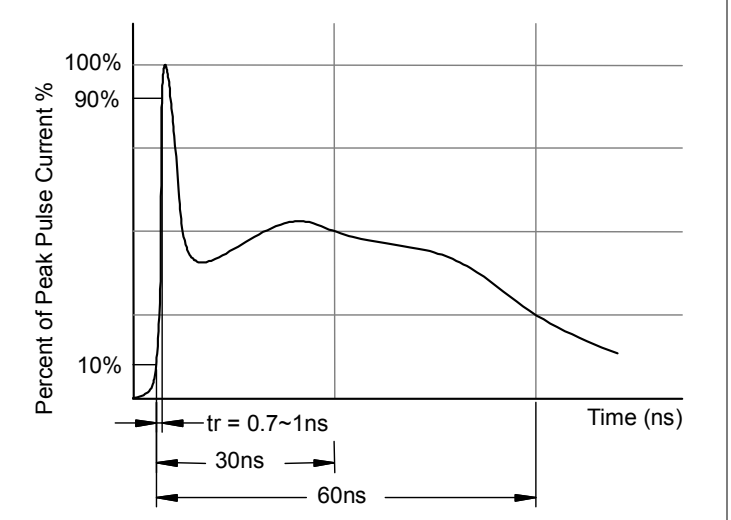
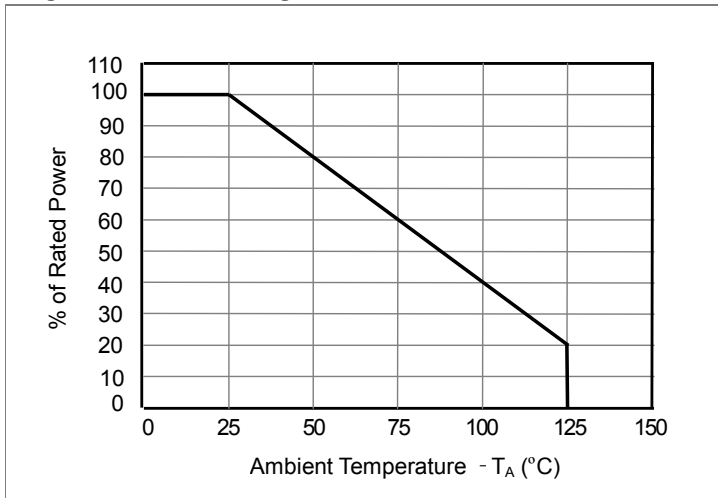
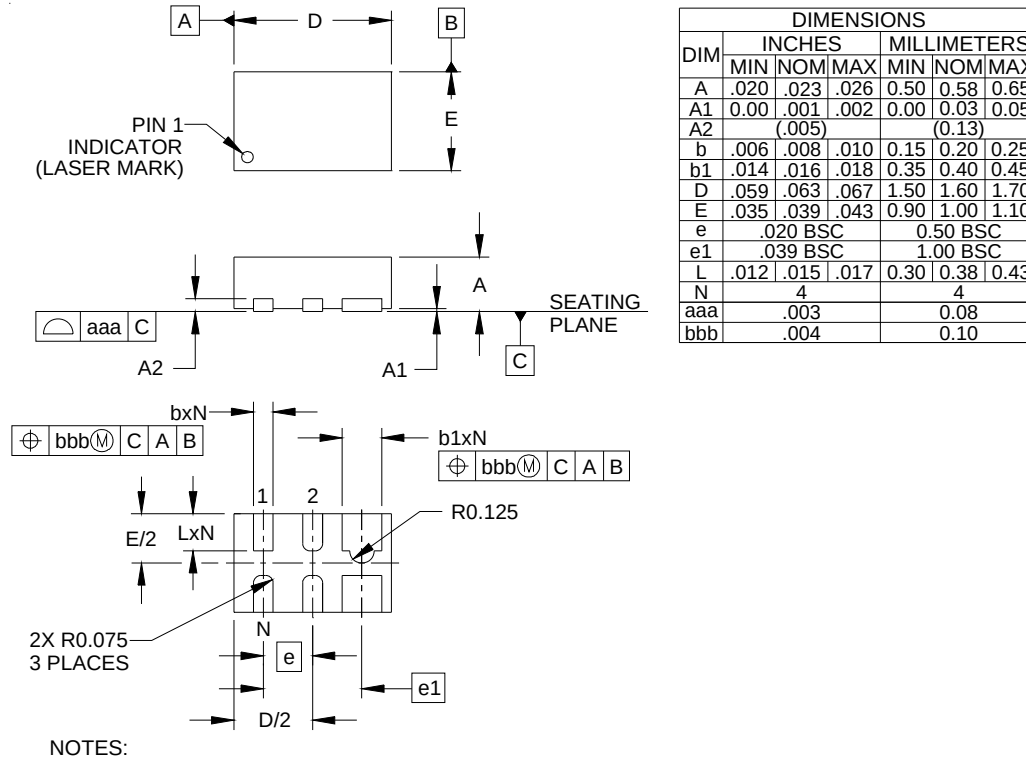


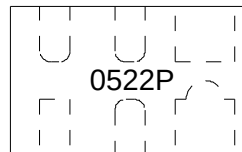
Fig3. Power Derating Curve



Outline Drawing - SLP1610P4



Marking



Ordering information

Order code	Package	Base qty	Delivery mode
UMW RCLAMP0522P	SLP1610P4	3000	Tape and reel